SiT9121

1 MHz - 220 MHz High Performance Differential Oscillator



Features

- Any frequency between 1 MHz and 220 MHz accurate to 6 decimal places
- LVPECL and LVDS output signaling types
- 0.6ps RMS phase jitter (random) over 12 kHz to 20 MHz bandwidth
- Frequency stability as low as ±10 ppm
- Industrial and extended commercial temperature ranges
- Industry-standard packages: 3.2 x 2.5, 5.0 x 3.2 and 7.0 x 5.0 mm x mm
- For other frequencies, refer to SiT9120 and SiT9122 datasheets

Applications

- 10 GB Ethernet, SONET, SATA, SAS, Fibre Channel, PCI-Express
- Telecom, networking, instrumentation, storage, server









Electrical Characteristics

Table 1. Electrical Characteristics

| Parameters | Symbol | Min. | Typ. | Max. | Unit | Condition | |
|-----------------------------------|------------|---------|---------|----------|-----------|--|--|
| - Tarameters | - Syllibol | | | | | I Characteristics | |
| Supply Voltage | Vdd | 2.97 | 3.3 | 3.63 | V | | |
| cupply reliage | Vuu | 2.25 | 2.5 | 2.75 | V | | |
| | | 2.25 | _ | 3.63 | V | Termination schemes in Figures 1 and 2 - XX ordering code | |
| Output Frequency Range | f | 1 | _ | 220 | MHz | 3 3 3 | |
| Frequency Stability | F_stab | -10 | _ | +10 | ppm | Inclusive of initial tolerance, operating temperature, | |
| | | -20 | - | +20 | ppm | rated power supply voltage, and load variations | |
| | | -25 | _ | +25 | ppm | | |
| | | -50 | _ | +50 | ppm | | |
| First Year Aging | F_aging1 | -2 | - | +2 | ppm | 25°C | |
| 10-year Aging | F_aging10 | -5 | - | +5 | ppm | 25°C | |
| Operating Temperature Range | T_use | -40 | _ | +85 | °C | Industrial | |
| | | -20 | _ | +70 | °C | Extended Commercial | |
| Input Voltage High | VIH | 70% | - | - | Vdd | Pin 1, OE or ST | |
| Input Voltage Low | VIL | - | _ | 30% | Vdd | Pin 1, OE or \overline{ST} | |
| Input Pull-up Impedance | Z_in | - | 100 | 250 | kΩ | Pin 1, OE logic high or logic low, or \overline{ST} logic high | |
| | | 2 | _ | _ | МΩ | Pin 1, ST logic low | |
| Start-up Time | T_start | - | 6 | 10 | ms | Measured from the time Vdd reaches its rated minimum value. | |
| Resume Time | T_resume | - | 6 | 10 | ms | In Standby mode, measured from the time \overline{ST} pin crosses 50% threshold. | |
| Duty Cycle | DC | 45 | - | 55 | % | Contact SiTime for tighter duty cycle | |
| | • | | LVPECL, | DC and A | C Charact | eristics | |
| Current Consumption | Idd | - | 61 | 69 | mA | Excluding Load Termination Current, Vdd = 3.3V or 2.5V | |
| OE Disable Supply Current | I_OE | - | - | 35 | mA | OE = Low | |
| Output Disable Leakage Current | l_leak | - | ı | 1 | μΑ | OE = Low | |
| Standby Current | I_std | - | - | 100 | μΑ | \overline{ST} = Low, for all Vdds | |
| Maximum Output Current | I_driver | _ | - | 30 | mA | Maximum average current drawn from OUT+ or OUT- | |
| Output High Voltage | VOH | Vdd-1.1 | - | Vdd-0.7 | V | See Figure 1(a) | |
| Output Low Voltage | VOL | Vdd-1.9 | _ | Vdd-1.5 | V | See Figure 1(a) | |
| Output Differential Voltage Swing | V_Swing | 1.2 | 1.6 | 2.0 | V | See Figure 1(b) | |
| Rise/Fall Time | Tr, Tf | - | 300 | 700 | ps | 20% to 80%, see Figure 1(a) | |
| OE Enable/Disable Time | T_oe | - | - | 115 | ns | f = 212.5 MHz - For other frequencies, T_oe = 100ns + 3 period | |
| RMS Period Jitter | T_jitt | _ | 1.2 | 1.7 | ps | f = 100 MHz, VDD = 3.3V or 2.5V | |
| | | _ | 1.2 | 1.7 | ps | f = 156.25 MHz, VDD = 3.3V or 2.5V | |
| | | - | 1.2 | 1.7 | ps | f = 212.5 MHz, VDD = 3.3V or 2.5V | |
| RMS Phase Jitter (random) | T_phj | - | 0.6 | 0.85 | ps | $f=156.25\ \mbox{MHz},$ Integration bandwidth = 12 kHz to 20 MHz, all Vdds | |



Table 1. Electrical Characteristics (continued)

| Parameter | Symbol | Min. | Тур. | Max. | Unit | Condition |
|--------------------------------|--------|-------|---------|----------|----------|--|
| | | | LVDS, D | C and AC | Characte | ristics |
| Current Consumption | Idd | ı | 47 | 55 | mA | Excluding Load Termination Current, Vdd = 3.3V or 2.5V |
| OE Disable Supply Current | I_OE | ı | ı | 35 | mA | OE = Low |
| Differential Output Voltage | VOD | 250 | 350 | 450 | mV | See Figure 2 |
| Output Disable Leakage Current | I_leak | - | - | 1 | μΑ | OE = Low |
| Standby Current | l_std | - | 1 | 100 | μΑ | ST = Low, for all Vdds |
| Delta VOD | ΔVOD | _ | - | 50 | mV | See Figure 2 |
| Offset Voltage | VOS | 1.125 | 1.2 | 1.375 | V | See Figure 2 |
| Delta VOS | ΔVOS | - | 1 | 50 | mV | See Figure 2 |
| Rise/Fall Time | Tr, Tf | _ | 495 | 700 | ps | 20% to 80%, see Figure 2 |
| OE Enable/Disable Time | T_oe | - | - | 115 | ns | f = 212.5 MHz - For other frequencies, T_oe = 100ns + 3 period |
| RMS Period Jitter | | _ | 1.2 | 1.7 | ps | f = 100 MHz, VDD = 3.3V or 2.5V |
| | T_jitt | - | 1.2 | 1.7 | ps | f = 156.25 MHz, VDD = 3.3V or 2.5V |
| | | _ | 1.2 | 1.7 | ps | f = 212.5 MHz, VDD = 3.3V or 2.5V |
| RMS Phase Jitter (random) | T_phj | _ | 0.6 | 0.85 | ps | f = 156.25 MHz, Integration bandwidth = 12 kHz to 20 MHz, all Vdds |

Table 2. Pin Description

| Pin | Мар | Functionality | | | | |
|-----|----------|---------------|--|--|--|--|
| | NC | NA | No Connect; Leave it floating or connect to GND for better heat dissipation | | | |
| 1 | OE | Input | H or Open: specified frequency output L: output is high impedance | | | |
| | ST Input | | H or Open: specified frequency output L: Device goes to sleep mode. Supply current reduces to I_std. | | | |
| 2 | NC | NA | No Connect; Leave it floating or connect to GND for better heat dissipation | | | |
| 3 | GND | Power | VDD Power Supply Ground | | | |
| 4 | OUT+ | Output | Oscillator output | | | |
| 5 | OUT- | Output | Complementary oscillator output | | | |
| 6 | VDD | Power | Power supply voltage | | | |

Top View

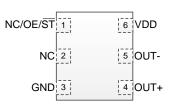


Figure 1. Pin Assignments



Table 3. Absolute Maximum Limits

Attempted operation outside the absolute maximum ratings of the part may cause permanent damage to the part. Actual performance of the IC is only guaranteed within the operational specifications, not at absolute maximum ratings.

| Parameter | Min. | Max. | Unit |
|--|------|------|------|
| Storage Temperature | -65 | 150 | °C |
| VDD | -0.5 | 4 | V |
| Electrostatic Discharge (HBM) | - | 2000 | V |
| Soldering Temperature (follow standard Pb free soldering guidelines) | _ | 260 | °C |

Table 4. Thermal Consideration^[1]

| Package | θJA, 4 Layer Board (°C/W) | θJC, Bottom (°C/W) |
|-------------|---------------------------|--------------------|
| 7050, 6-pin | 142 | 27 |
| 5032, 6-pin | 97 | 20 |
| 3225, 6-pin | 109 | 20 |

Note:

1. Refer to JESD51-7 for θ JA and θ JC definitions, and reference layout used to determine the θ JA and θ JC values in the above table.

Table 5. Maximum Operating Junction Temperature^[2]

| Max Operating Temperature (ambient) | Maximum Operating Junction Temperature | | |
|-------------------------------------|--|--|--|
| 70°C | 90°C | | |
| 85°C | 105°C | | |

Note:

2. Datasheet specifications are not guaranteed if junction temperature exceeds the maximum operating junction temperature.

Table 6. Environmental Compliance

| Parameter | Condition/Test Method |
|----------------------------|--------------------------|
| Mechanical Shock | MIL-STD-883F, Method2002 |
| Mechanical Vibration | MIL-STD-883F, Method2007 |
| Temperature Cycle | JESD22, Method A104 |
| Solderability | MIL-STD-883F, Method2003 |
| Moisture Sensitivity Level | MSL1 @ 260°C |



Waveform Diagrams

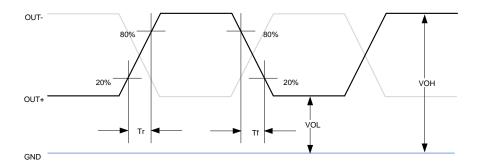


Figure 1(a). LVPECL Voltage Levels per Differential Pin (i.e. OUT+, or OUT-)

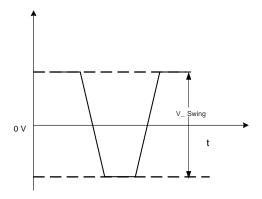


Figure 1(b). LVPECL Voltage Levels Across Differential Pair (i.e. OUT+ minus OUT-)

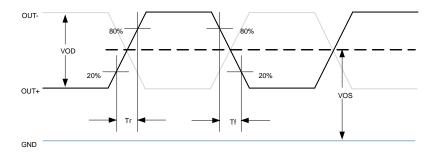


Figure 2. LVDS Voltage Levels per Differential Pin (i.e. OUT+, or OUT-)



Termination Diagrams

LVPECL

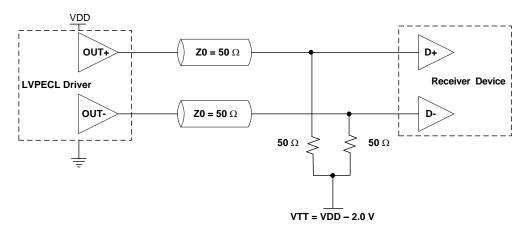


Figure 3. LVPECL Typical Termination

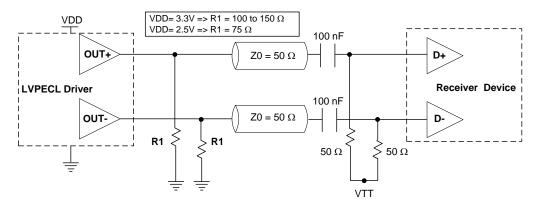


Figure 4. LVPECL AC Coupled Termination

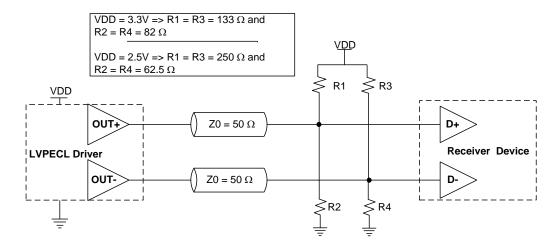


Figure 5. LVPECL with Thevenin Typical Termination



Termination Diagrams (continued)

LVDS

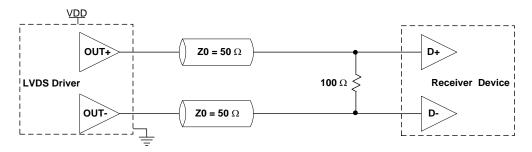
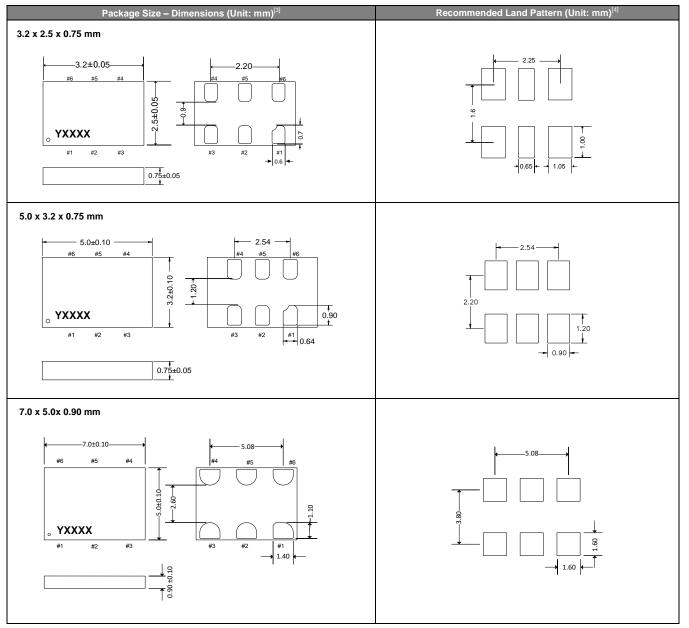


Figure 6. LVDS Single Termination (Load Terminated)



Dimensions and Patterns



Notes:

- 3. Top Marking: Y denotes manufacturing origin and XXXX denotes manufacturing lot number. The value of "Y" will depend on the assembly location of the device.
- 4. A capacitor of value 0.1 μF between VDD and GND is recommended.



Ordering Information

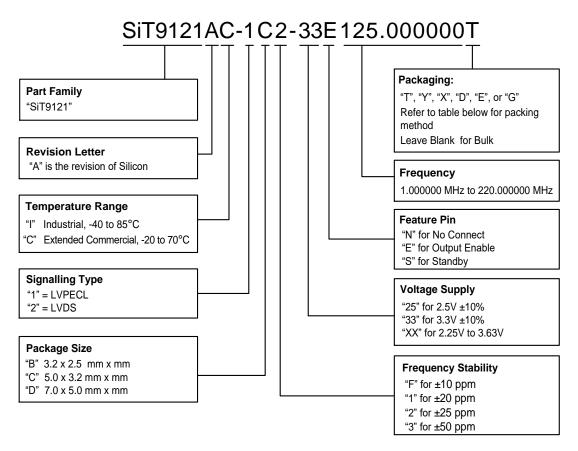


Table 7. Frequencies Not Supported

| Frequency Range | | | | | |
|-----------------|----------------|--|--|--|--|
| Min. Max. | | | | | |
| 209.000001 MHz | 210.999999 MHz | | | | |

Table 8. Ordering Codes for Supported Tape & Reel Packing Method

| Device Size | 8 mm T&R (3ku) | 8 mm T&R (1ku) | 8 mm T&R (250u) | 12 mm T&R (3ku) | 12 mm T&R (1ku) | 12 mm T&R (250u) | 16 mm T&R (3ku) | 16 mm T&R (1ku) | 16 mm T&R (250u) |
|--------------|-------------------|-------------------|--------------------|--------------------|--------------------|---------------------|--------------------|--------------------|---------------------|
| 7.0 x 5.0 mm | - | - | - | - | - | - | Т | Υ | Х |
| 5.0 x 3.2 mm | - | - | - | Т | Y | Х | _ | - | - |
| 3.2 x 2.5 mm | D | Е | G | Т | Y | Х | - | - | - |



Table 9. Revision History

| Revisions | Release Date | Change Summary | |
|-----------|--------------|---|--|
| 1.01 | 02/20/2013 | Original | |
| 1.02 | 12/03/2013 | Added input specifications, LVPECL/LVDS waveforms, packaging T&R options | |
| 1.03 | 02/06/2014 | Added 8mm T&R option and ±10 ppm | |
| 1.04 | 04/08/2014 | Included 1.8V option for LVDS output only | |
| 1.05 | 07/30/2014 | Included Thermal Consideration table | |
| 1.06 | 10/20/2014 | Modified Thermal Consideration values. Preliminary removed from the title | |
| 1.07 | 04/03/2017 | Removed 1.8V option | |
| 1.08 | 08/17/2019 | Added No Connect feature to Pin 1 Added Table 5: Maximum Operating Junction Temperature Updated logo and company address, other page layout changes | |

SiTime Corporation, 5451 Patrick Henry Drive, Santa Clara, CA 95054, USA | **Phone**: +1-408-328-4400 | **Fax**: +1-408-328-4439

© SiTime Corporation 2013-2019. The information contained herein is subject to change at any time without notice. SiTime assumes no responsibility or liability for any loss, damage or defect of a Product which is caused in whole or in part by (i) use of any circuitry other than circuitry embodied in a SiTime product, (ii) misuse or abuse including static discharge, neglect or accident, (iii) unauthorized modification or repairs which have been soldered or altered during assembly and are not capable of being tested by SiTime under its normal test conditions, or (iv) improper installation, storage, handling, warehousing or transportation, or (v) being subjected to unusual physical, thermal, or electrical stress.

Disclaimer: SiTime makes no warranty of any kind, express or implied, with regard to this material, and specifically disclaims any and all express or implied warranties, either in fact or by operation of law, statutory or otherwise, including the implied warranties of merchantability and fitness for use or a particular purpose, and any implied warranty arising from course of dealing or usage of trade, as well as any common-law duties relating to accuracy or lack of negligence, with respect to this material, any SiTime product and any product documentation. Products sold by SiTime are not suitable or intended to be used in a life support application or component, to operate nuclear facilities, or in other mission critical applications where human life may be involved or at stake. All sales are made conditioned upon compliance with the critical uses policy set forth below.

CRITICAL USE EXCLUSION POLICY

BUYER AGREES NOT TO USE SITIME'S PRODUCTS FOR ANY APPLICATION OR IN ANY COMPONENTS USED IN LIFE SUPPORT DEVICES OR TO OPERATE NUCLEAR FACILITIES OR FOR USE IN OTHER MISSION-CRITICAL APPLICATIONS OR COMPONENTS WHERE HUMAN LIFE OR PROPERTY MAY BE AT STAKE.

SiTime owns all rights, title and interest to the intellectual property related to SiTime's products, including any software, firmware, copyright, patent, or trademark. The sale of SiTime products does not convey or imply any license under patent or other rights. SiTime retains the copyright and trademark rights in all documents, catalogs and plans supplied pursuant to or ancillary to the sale of products or services by SiTime. Unless otherwise agreed to in writing by SiTime, any reproduction, modification, translation, compilation, or representation of this material shall be strictly prohibited.



Supplemental Information

The Supplemental Information section is not part of the datasheet and is for informational purposes only.



Best Reliability

Silicon is inherently more reliable than quartz. Unlike quartz suppliers, SiTime has in-house MEMS and analog CMOS expertise, which allows SiTime to develop the most reliable products. Figure 1 shows a comparison with quartz technology.

Why is SiTime Best in Class:

- SiTime's MEMS resonators are vacuum sealed using an advanced EpiSeal™ process, which eliminates foreign particles and improves long term aging and reliability
- World-class MEMS and CMOS design expertise

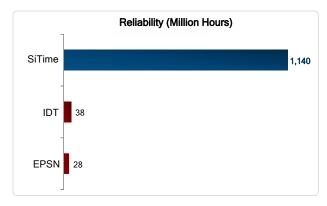


Figure 1. Reliability Comparison[1]

Best Aging

Unlike quartz, MEMS oscillators have excellent long term aging performance which is why every new SiTime product specifies 10-year aging. A comparison is shown in Figure 2.

Why is SiTime Best in Class:

- SiTime's MEMS resonators are vacuum sealed using an advanced EpiSeal[™] process, which eliminates foreign particles and improves long term aging and reliability
- Inherently better immunity of electrostatically driven MEMS resonator

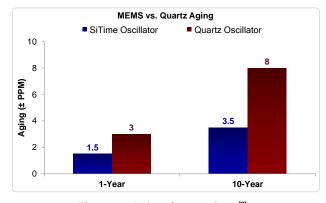


Figure 2. Aging Comparison[2]

Best Electro Magnetic Susceptibility (EMS)

SiTime's oscillators in plastic packages are up to 54 times more immune to external electromagnetic fields than quartz oscillators as shown in Figure 3.

Why is SiTime Best in Class:

- Internal differential architecture for best common mode noise rejection
- Electrostatically driven MEMS resonator is more immune to EMS

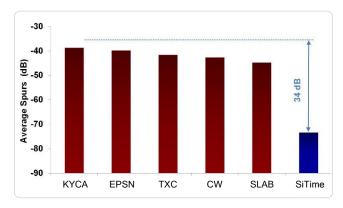


Figure 3. Electro Magnetic Susceptibility (EMS)[3]

Best Power Supply Noise Rejection

SiTime's MEMS oscillators are more resilient against noise on the power supply. A comparison is shown in Figure 4.

Why is SiTime Best in Class:

- On-chip regulators and internal differential architecture for common mode noise rejection
- MEMS resonator is paired with advanced analog CMOS IC

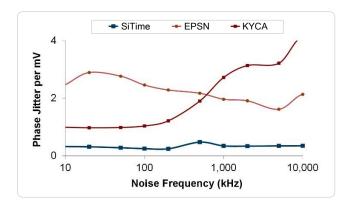


Figure 4. Power Supply Noise Rejection[4]



Best Vibration Robustness

High-vibration environments are all around us. All electronics, from handheld devices to enterprise servers and storage systems are subject to vibration. Figure 5 shows a comparison of vibration robustness.

Why is SiTime Best in Class:

- The moving mass of SiTime's MEMS resonators is up to 3000 times smaller than quartz
- Center-anchored MEMS resonator is the most robust design

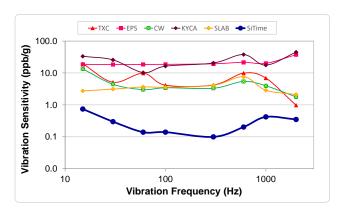


Figure 5. Vibration Robustness^[5]

Figure labels:

- TXC = TXC
- Epson = EPSN
- Connor Winfield = CW
- Kyocera = KYCA
- SiLabs = SLAB
- SiTime = EpiSeal MEMS

Best Shock Robustness

SiTime's oscillators can withstand at least $50,000\ g$ shock. They all maintain their electrical performance in operation during shock events. A comparison with quartz devices is shown in Figure 6.

Why is SiTime Best in Class:

- The moving mass of SiTime's MEMS resonators is up to 3000 times smaller than quartz
- Center-anchored MEMS resonator is the most robust design

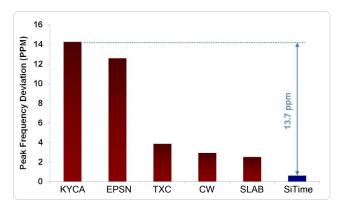


Figure 6. Shock Robustness^[6]

Silicon MEMS Outperforms Quartz



Notes:

- 1. Data source: Reliability documents of named companies.
- 2. Data source: SiTime and quartz oscillator devices datasheets.
- 3. Test conditions for Electro Magnetic Susceptibility (EMS):
 - According to IEC EN61000-4.3 (Electromagnetic compatibility standard)
 - Field strength: 3V/m
 - Radiated signal modulation: AM 1 kHz at 80% depth
 - Carrier frequency scan: 80 MHz 1 GHz in 1% steps
 - Antenna polarization: Vertical
 - DUT position: Center aligned to antenna

Devices used in this test:

| Label | Manufacturer | Part Number | Technology |
|--------------|-----------------|-----------------------------|--|
| EpiSeal MEMS | SiTime | SiT9120AC-1D2-33E156.250000 | MEMS + PLL |
| EPSN | Epson | EG-2102CA156.2500M-PHPAL3 | Quartz, SAW |
| TXC | TXC | BB-156.250MBE-T | Quartz, 3 rd Overtone |
| CW | Conner Winfield | P123-156.25M | Quartz, 3 rd Overtone |
| KYCA | AVX Kyocera | KC7050T156.250P30E00 | Quartz, SAW |
| SLAB | SiLab | 590AB-BDG | Quartz, 3 rd Overtone + PLL |

4. 50 mV pk-pk Sinusoidal voltage.

Devices used in this test:

| Label | Manufacturer | Part Number | Technology |
|--------------|--------------|----------------------------|------------|
| EpiSeal MEMS | SiTime | SiT8208AI-33-33E-25.000000 | MEMS + PLL |
| NDK | NDK | NZ2523SB-25.6M | Quartz |
| KYCA | AVX Kyocera | KC2016B25M0C1GE00 | Quartz |
| EPSN | Epson | SG-310SCF-25M0-MB3 | Quartz |

5. Devices used in this test:

same as EMS test stated in Note 3.

- 6. Test conditions for shock test:
 - MIL-STD-883F Method 2002
 - Condition A: half sine wave shock pulse, 500-g, 1ms
 - Continuous frequency measurement in 100 μs gate time for 10 seconds

Devices used in this test:

same as EMS test stated in Note 3.

7. Additional data, including setup and detailed results, is available upon request to qualified customer. Please contact productsupport@sitime.com.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Standard Clock Oscillators category:

Click to view products by SiTime manufacturer:

Other Similar products are found below:

601252 F335-12 F335-25 F535L-33.333 F535L-50 ASV-20.000MHZ-LR-T ECS-2018-160-BN-TR MXO45HS-2C-66.6666MHZ

SiT8209AI-32-33E-125.000000 SIT8918AA-11-33S-50.000000G SM4420TEV-40.0M-T1K F335-24 F335-40 F535L-10 F535L-12 F535L
16 F535L-24 F535L-27 F535L-48 PE7744DW-100.0M CSX-750FCC14745600T ASF1-3.686MHZ-N-K-S XO57CTECNA3M6864 ECS
2100A-147.4 601251 EP16E7E2H26.000MTR SIT8918AA-11-33S-16.000000G XO3003 9120AC-2D2-33E212.500000 9102AI
243N25E100.00000 8208AC-82-18E-25.00000 8008AI-72-XXE-24.545454E 8004AC-13-33E-133.33000X AS-4.9152-16-SMD-TR ASFL1
48.000MHZ-LC-T SIT8920AM-31-33E-25.0000 DSC1028DI2-019.2000 9121AC-2C3-25E100.00000 9102AI-233N33E100.00000X

9102AI-233N25E200.00000 9102AI-232H25S125.00000 9102AI-133N25E200.00000 9102AC-283N25E200.00000 9001AC-33-33E1-30.000

XLH536125.000JS4I 3921AI-2CF-33NZ125.000000 5730-1SF PXA000010 SIT1602BC-83-33E-10.0000000Y 8003AI-12-33S-40.000000Y